

BB202LX

Low-voltage variable capacitance diode

Rev. 2 — 7 September 2011

Preliminary data sheet

1. Product profile

1.1 General description

The BB202LX is a planar technology variable capacitance diode in a SOD882T ultra small leadless plastic SMD package.

1.2 Features and benefits

- Very steep Capacitance-Voltage (CV) curve
- C_{d(0V2)}: 30.5 pF; C_{d(2V3)}: 9.5 pF
- Ratio C_{d(0V2)} to C_{d(2V3)} minimal 2.5
- Ultra small leadless SMD package
- Low series resistance

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Electronic tuning in FM radios
- Recommended as the reference VCO varactor for Philips Tuner ICs TEA5764, TEA5767 and TEA5768 in mobile and portable platforms

2. Pinning information

Table 1. Discrete pinning

1 cathode [1]	nbol
2 anada	
2 anode Transparent top view	sym008

[1] The marking bar indicates the cathode.



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3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
BB202LX	-	leadless ultra small plastic package; 2 terminals; body 1.0 \times 0.6 \times 0.4 mm	SOD882T	

4. Marking

Table 3. Marking

Type number	Marking code
BB202LX	L1

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	6	V
I _F	forward current		-	10	mA
T _{stg}	storage temperature		-55	+85	°C
Tj	junction temperature		-55	+85	°C

6. Characteristics

Table 5. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _R reverse current		see Figure 3					
		V _R = 6 V		-	-	10	nA
	V _R = 6 V; T _j = 85 °C		-	-	100	nΑ	
r _s	diode series resistance	f = 100 MHz; see Figure 2	<u>[1]</u>	-	0.35	-	Ω
C _d diode capacitance	diode capacitance	see Figure 1 and Figure 4; f = 1 MHz;					
		V _R = 0.2 V		28.2	-	33.5	рF
		V _R = 2.3 V		7.2	-	11.2	pF
$\frac{C_{d(0V2)}}{C_{d(2V3)}}$	diode capacitance ratio	f = 1 MHz		2.5	-	-	

^[1] r_s is the value at which C_d = 30 pF.

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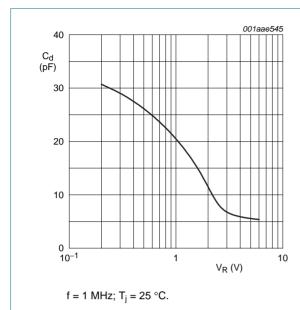
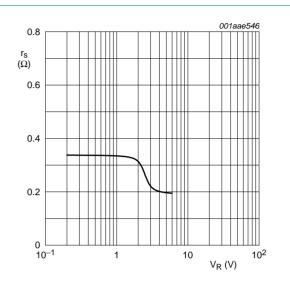


Fig 1. Diode capacitance as a function of reverse voltage; typical values



 $f = 470 \text{ MHz}; T_j = 25 \,^{\circ}\text{C}.$

Fig 2. Diode serial resistance as a function of reverse voltage; typical values

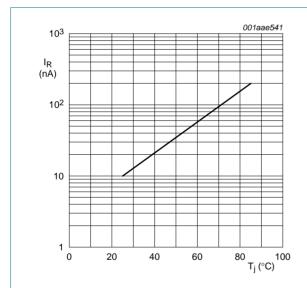
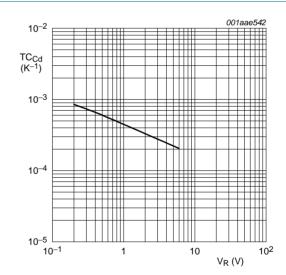


Fig 3. Reverse current as a function of junction temperature; maximum values



 $T_j = 0$ °C to 85 °C.

Fig 4. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

7. Package outline

Leadless ultra small plastic package; 2 terminals; body 1 x 0.6 x 0.4 mm SOD882T (2×) L₁ (2×) ⊕ wM A b (2×) (2×) = | w (M) | B e₁ Α (1) В 1 mm scale **DIMENSIONS (mm are the original dimensions)** A_1 UNIT Ε Α D L₁ у max 0.40 0.55 0.65 1.05 0.04 0.65 0.1 0.03 mm 0.36 0.45 0.55 0.95 Note 1. The marking bar indicates the cathode **REFERENCES** OUTLINE **EUROPEAN ISSUE DATE** PROJECTION VERSION IEC **JEDEC JEITA** 04-12-14 SOD882T 06-04-12

Fig 5. Package outline SOD882T

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8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BB202LX v.2	20110907	Preliminary data sheet	-	BB202LX v.1	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts 	s have been adapted to the ne	w company name whe	ere appropriate.	
 Package outline drawings have been updated to the latest version. 					
BB202LX v.1	20060411	Preliminary data sheet	-	-	

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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